



<p>© FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED.</p>	<p><b>MECHANICAL OUTLINE</b></p>	<p>PRINT VERSION NOT TO SCALE</p>	
<p>TITLE:  8LD SOIC · NARROW BODY</p>	<p>DOCUMENT NO: 98ASB42564B</p>	<p>REV: V</p>	
	<p>CASE NUMBER: 751-07</p>	<p>20 NOV 2007</p>	
	<p>STANDARD: JEDEC MS-012AA</p>		

## NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.

2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

3. DIMENSION DOES NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

4. DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE DIMENSION AT MAXIMUM MATERIAL CONDITION.

© FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED.	<b>MECHANICAL OUTLINE</b>	PRINT VERSION NOT TO SCALE	
TITLE:  8LD SOIC NARROW BODY	DOCUMENT NO: 98ASB42564B	REV: V	
	CASE NUMBER: 751-07	20 NOV 2007	
	STANDARD: JEDEC MS-012AA		